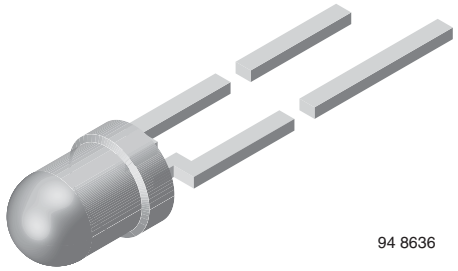
High Speed Infrared Emitting Diode, 940 nm, Surface Emitter Technology



FEATURES

- Package type: leaded
- Package form: T-1, clear epoxy
- Dimensions: Ø 3 mm
- Peak wavelength: λ_p = 940 nm
- High speed
- High radiant power
- High radiant intensity
- Angle of half intensity: φ = ± 17°
- Low forward voltage
- Good spectral matching to Si photodetectors
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

e2

RoHS COMPLIANT

HALOGEN FREE

GREEN (5-2008)

DESCRIPTION

As part of the SurfLight™ portfolio, the VSLY3943 is a high speed infrared emitting diode based on surface emitter technology, molded in a blue-gray plastic package.

APPLICATIONS

- Infrared remote control units
- Free air transmission systems
- Infrared source for optical counters and card readers

PRODUCT SUMMARY				
COMPONENT	I_e (mW/sr)	φ (deg)	λ_p (nm)	t_r (ns)
VSLY3943	70	± 17	940	5

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSLY3943	Bulk	MOQ: 5000 pcs, 5000 pcs/bulk	T-1
VSLY3943-MSZ	Ammopack	MOQ: 10 000 pcs, 2000 pcs/box	T-1

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	5	V
Forward current		I_F	70	mA
Peak forward current	t_p/T = 0.1, t_p = 100 µs	I_{FM}	140	mA
Surge forward current	t_p = 100 µs	I_{FSM}	500	mA
Power dissipation		P_V	160	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	-40 to +85	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	t ≤ 5 s, 2 mm from case	T_{sd}	260	°C
Thermal resistance junction-to-ambient	J-STD-051, leads 7 mm, soldered on PCB	R_{thJA}	300	K/W

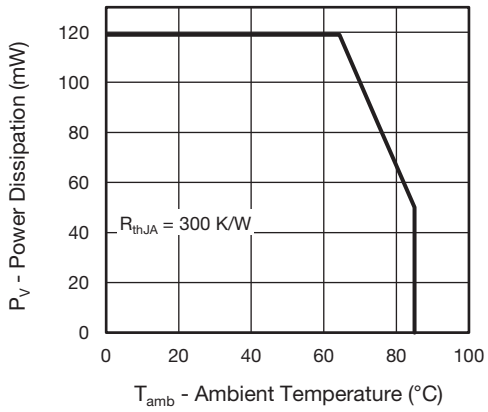


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

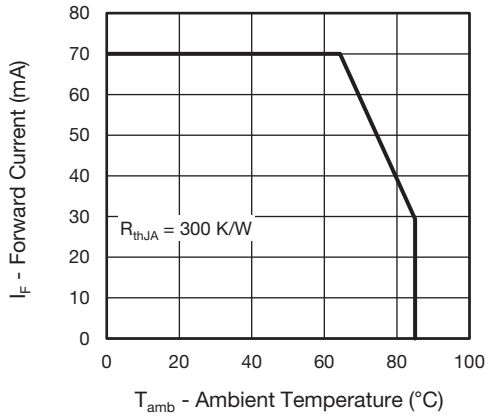


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I_F = 70 mA, t_p = 20 ms	V_F	-	1.5	1.7	V
	I_F = 500 mA, t_p = 100 µs	V_F	-	2.6	-	V
Temperature coefficient of V_F	I_F = 50 mA	TK_{VF}	-	-0.7	-	mV/K
Reverse current	V_R = 5 V	I_R	Not designed for reverse operation			µA
Junction capacitance	V_R = 0 V, f = 1 MHz, E = 0 mW/cm²	C_J	-	30	-	pF
Radiant intensity	I_F = 70 mA, t_p = 20 ms	I_e	32	70	120	mW/sr
	I_F = 500 mA, t_p = 100 µs	I_e	-	650	-	mW/sr
Radiant power	I_F = 70 mA, t_p = 20 ms	ϕe	-	40	-	mW
Temperature coefficient of radiant power	I_F = 50 mA	$TK_{\varphi e}$	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 17	-	deg
Peak wavelength	I_F = 50 mA	λ_p	-	940	-	nm
Spectral bandwidth	I_F = 70 mA	$\Delta\lambda$	-	55	-	nm
Temperature coefficient of I_p	I_F = 70 mA	$TK_{\lambda p}$	-	0.28	-	nm
Rise time	I_F = 70 mA, 10 % to 90 %	t_r	-	5	-	ns
Fall time	I_F = 70 mA, 10 % to 90 %	t_f	-	6	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

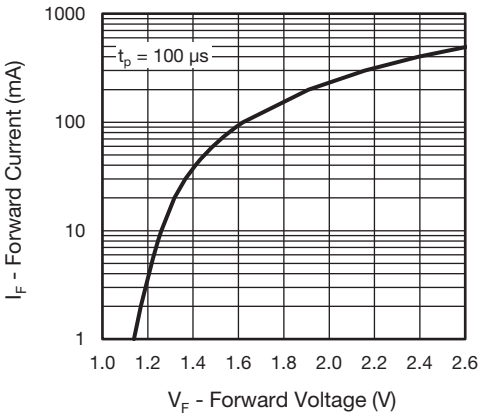


Fig. 3 - Forward Current vs. Forward Voltage

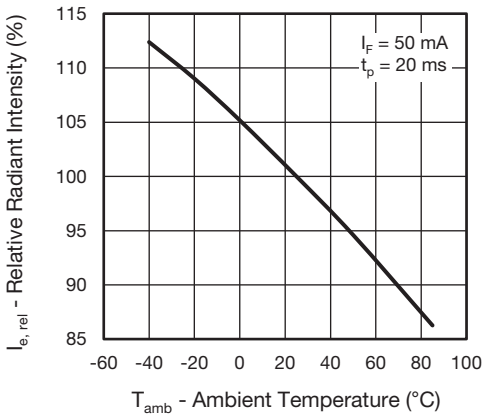


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

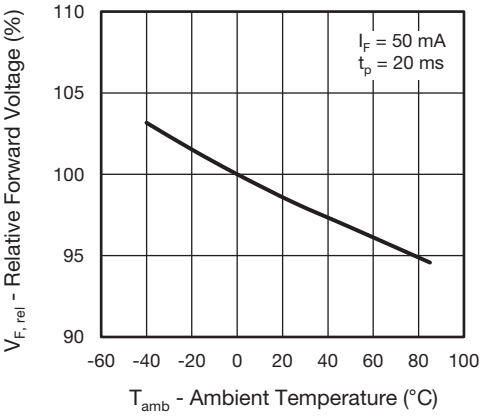


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

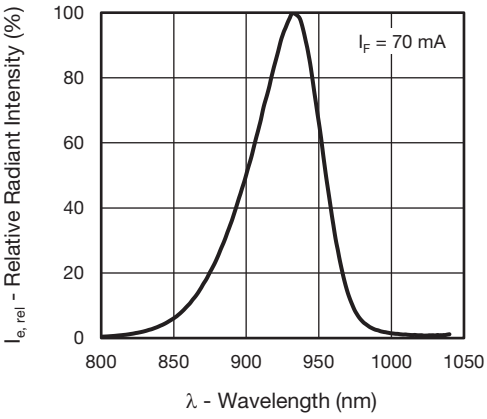


Fig. 7 - Relative Radiant Intensity vs. Wavelength

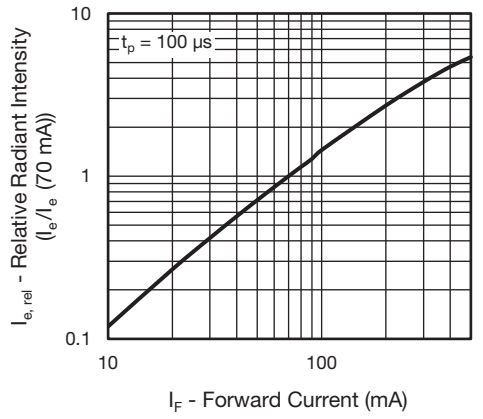


Fig. 5 - Relative Radiant Intensity vs. Forward Current

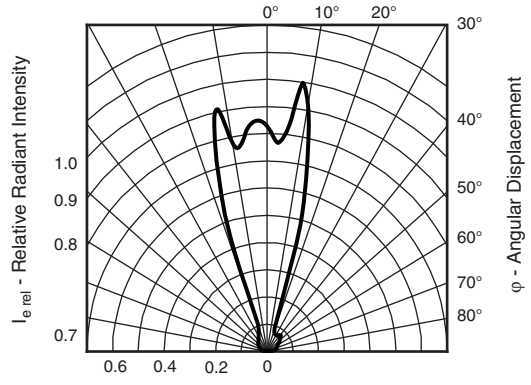
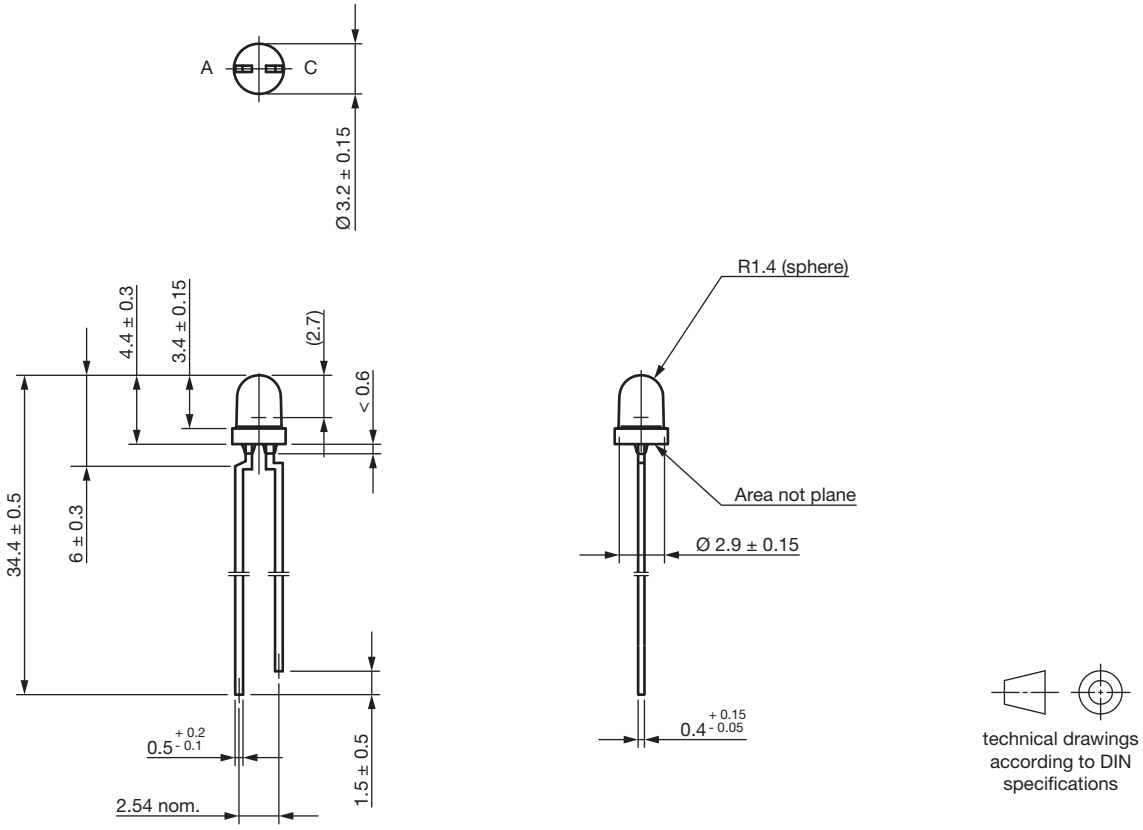


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

PACKAGE DIMENSIONS in millimeters



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